

## IGBT

IGBT with integrated diode in packages offering space saving advantage

## IKD15N60RA

600V TRENCHSTOP™ RC-Series for hard switching applications

Data sheet

Industrial Power Control

IGBT with integrated diode in packages offering space saving advantage

### Features:

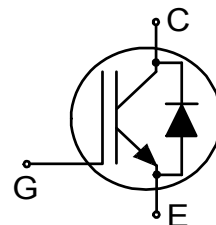
TRENCHSTOP™ Reverse Conducting (RC) technology for 600V applications offering

- Optimised  $V_{CEsat}$  and  $V_F$  for low conduction losses
- Smooth switching performance leading to low EMI levels
- Very tight parameter distribution
- Operating range of 1 to 20kHz
- Maximum junction temperature 175°C
- Short circuit capability of 5μs
- Best in class current versus package size performance
- Qualified according to AECQ101
- Pb-free lead plating; RoHS compliant (for PG-TO252: solder temperature 260°C, MSL1)

Complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>

### Applications:

- HID lighting
- Piezo injection



### Key Performance and Package Parameters

| Type       | $V_{CE}$ | $I_C$ | $V_{CEsat}$ , $T_{vj}=25^\circ\text{C}$ | $T_{vjmax}$ | Marking | Package    |
|------------|----------|-------|-----------------------------------------|-------------|---------|------------|
| IKD15N60RA | 600V     | 15A   | 1.65V                                   | 175°C       | K15R60A | PG-TO252-3 |

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### Maximum ratings

| Parameter                                                                                                                                                                               | Symbol      | Value        | Unit        |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|--------------|-------------|
| Collector-emitter voltage                                                                                                                                                               | $V_{CE}$    | 600          | V           |
| DC collector current, limited by $T_{vjmax}$<br>$T_C = 25^{\circ}C$<br>$T_C = 100^{\circ}C$                                                                                             | $I_C$       | 30.0<br>15.0 | A           |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$                                                                                                                                  | $I_{Cpuls}$ | 45.0         | A           |
| Turn off safe operating area $V_{CE} \leq 600V$ , $T_{vj} \leq 175^{\circ}C$                                                                                                            | -           | 45.0         | A           |
| Diode forward current, limited by $T_{vjmax}$<br>$T_C = 25^{\circ}C$<br>$T_C = 100^{\circ}C$                                                                                            | $I_F$       | 30.0<br>15.0 | A           |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$                                                                                                                                      | $I_{Fpuls}$ | 45.0         | A           |
| Gate-emitter voltage                                                                                                                                                                    | $V_{GE}$    | $\pm 20$     | V           |
| Short circuit withstand time<br>$V_{GE} = 15.0V$ , $V_{CC} \leq 400V$<br>Allowed number of short circuits < 1000<br>Time between short circuits: $\geq 1.0s$<br>$T_{vj} = 150^{\circ}C$ | $t_{SC}$    | 5            | $\mu s$     |
| Power dissipation $T_C = 25^{\circ}C$                                                                                                                                                   | $P_{tot}$   | 250.0        | W           |
| Operating junction temperature                                                                                                                                                          | $T_{vj}$    | $-40...+175$ | $^{\circ}C$ |
| Storage temperature                                                                                                                                                                     | $T_{stg}$   | $-55...+175$ | $^{\circ}C$ |
| Soldering temperature,<br>reflow soldering (MSL1 according to JEDEC J-STA-020)                                                                                                          |             | 260          | $^{\circ}C$ |

### Thermal Resistance

| Parameter                                                               | Symbol        | Conditions | Max. Value | Unit |
|-------------------------------------------------------------------------|---------------|------------|------------|------|
| <b>Characteristic</b>                                                   |               |            |            |      |
| IGBT thermal resistance,<br>junction - case                             | $R_{th(j-c)}$ |            | 0.60       | K/W  |
| Diode thermal resistance,<br>junction - case                            | $R_{th(j-c)}$ |            | 2.00       | K/W  |
| Thermal resistance, min. footprint<br>junction - ambient                | $R_{th(j-a)}$ |            | 75         | K/W  |
| Thermal resistance, 6cm <sup>2</sup> Cu on<br>PCB<br>junction - ambient | $R_{th(j-a)}$ |            | 50         | K/W  |

**Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified**

| Parameter                            | Symbol        | Conditions                                                                         | Value  |              |                | Unit     |
|--------------------------------------|---------------|------------------------------------------------------------------------------------|--------|--------------|----------------|----------|
|                                      |               |                                                                                    | min.   | typ.         | max.           |          |
| Static Characteristic                |               |                                                                                    |        |              |                |          |
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE} = 0V, I_C = 0.20mA$                                                        | 600    | -            | -              | V        |
| Collector-emitter saturation voltage | $V_{CEsat}$   | $V_{GE} = 15.0V, I_C = 15.0A$<br>$T_{vj} = 25^{\circ}C$<br>$T_{vj} = 175^{\circ}C$ | -<br>- | 1.65<br>1.85 | 2.10<br>-      | V        |
| Diode forward voltage                | $V_F$         | $V_{GE} = 0V, I_F = 15.0A$<br>$T_{vj} = 25^{\circ}C$<br>$T_{vj} = 175^{\circ}C$    | -<br>- | 1.70<br>1.70 | 2.10<br>-      | V        |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C = 0.25mA, V_{CE} = V_{GE}$                                                    | 4.3    | 5.0          | 5.7            | V        |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE} = 600V, V_{GE} = 0V$<br>$T_{vj} = 25^{\circ}C$<br>$T_{vj} = 175^{\circ}C$  | -<br>- | -<br>-       | 40.0<br>1000.0 | $\mu A$  |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE} = 0V, V_{GE} = 20V$                                                        | -      | -            | 100            | nA       |
| Transconductance                     | $g_{fs}$      | $V_{CE} = 20V, I_C = 15.0A$                                                        | -      | 9.4          | -              | S        |
| Integrated gate resistor             | $r_G$         |                                                                                    |        | none         |                | $\Omega$ |

**Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified**

| Parameter                                                                                          | Symbol             | Conditions                                                             | Value |      |      | Unit |
|----------------------------------------------------------------------------------------------------|--------------------|------------------------------------------------------------------------|-------|------|------|------|
|                                                                                                    |                    |                                                                        | min.  | typ. | max. |      |
| Dynamic Characteristic                                                                             |                    |                                                                        |       |      |      |      |
| Input capacitance                                                                                  | C <sub>ies</sub>   | V <sub>CE</sub> = 25V, V <sub>GE</sub> = 0V, f = 1MHz                  | -     | 961  | -    | pF   |
| Output capacitance                                                                                 | C <sub>oes</sub>   |                                                                        | -     | 53   | -    |      |
| Reverse transfer capacitance                                                                       | C <sub>res</sub>   |                                                                        | -     | 33   | -    |      |
| Gate charge                                                                                        | Q <sub>G</sub>     | V <sub>CC</sub> = 480V, I <sub>C</sub> = 15.0A, V <sub>GE</sub> = 15V  | -     | 90.0 | -    | nC   |
| Internal emitter inductance<br>measured 5mm (0.197 in.) from<br>case                               | L <sub>E</sub>     |                                                                        | -     | 7.0  | -    | nH   |
| Short circuit collector current<br>Max. 1000 short circuits<br>Time between short circuits: ≥ 1.0s | I <sub>C(SC)</sub> | V <sub>GE</sub> = 15.0V, V <sub>CC</sub> ≤ 400V, t <sub>SC</sub> ≤ 5μs | -     |      | -    | A    |

**Switching Characteristic, Inductive Load**

| Parameter                                             | Symbol              | Conditions                                                                                                                                                                                                                            | Value |      |      | Unit |
|-------------------------------------------------------|---------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
|                                                       |                     |                                                                                                                                                                                                                                       | min.  | typ. | max. |      |
| IGBT Characteristic, at $T_{vj} = 25^{\circ}\text{C}$ |                     |                                                                                                                                                                                                                                       |       |      |      |      |
| Turn-on delay time                                    | $t_{d(\text{on})}$  | $T_{vj} = 25^{\circ}\text{C}$ ,<br>$V_{CC} = 400\text{V}$ , $I_C = 15.0\text{A}$ ,<br>$V_{GE} = 0.0/15.0\text{V}$ ,<br>$r_G = 15.0\Omega$ , $L\sigma = 60\text{nH}$ ,<br>$C\sigma = 40\text{pF}$<br>$L\sigma$ , $C\sigma$ from Fig. E | -     | 16   | -    | ns   |
| Rise time                                             | $t_r$               |                                                                                                                                                                                                                                       | -     | 10   | -    | ns   |
| Turn-off delay time                                   | $t_{d(\text{off})}$ |                                                                                                                                                                                                                                       | -     | 183  | -    | ns   |
| Fall time                                             | $t_f$               |                                                                                                                                                                                                                                       | -     | 136  | -    | ns   |
| Turn-on energy                                        | $E_{\text{on}}$     |                                                                                                                                                                                                                                       | -     | 0.37 | -    | mJ   |
| Turn-off energy                                       | $E_{\text{off}}$    |                                                                                                                                                                                                                                       | -     | 0.53 | -    | mJ   |
| Total switching energy                                | $E_{\text{ts}}$     |                                                                                                                                                                                                                                       | -     | 0.90 | -    | mJ   |

**Diode Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$** 

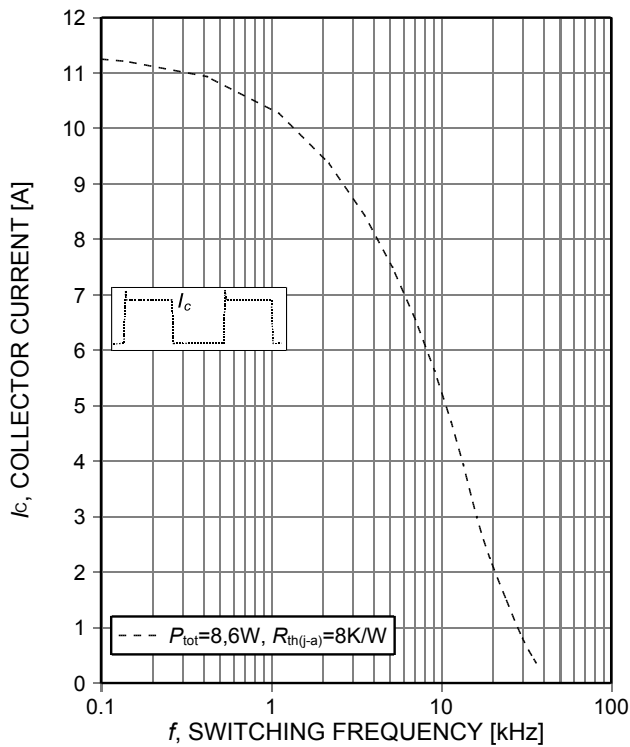
|                                                                  |              |                                                                                                                            |   |       |   |                        |
|------------------------------------------------------------------|--------------|----------------------------------------------------------------------------------------------------------------------------|---|-------|---|------------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_{vj} = 25^{\circ}\text{C}$ ,<br>$V_R = 400\text{V}$ ,<br>$I_F = 15.0\text{A}$ ,<br>$di_F/dt = 1300\text{A}/\mu\text{s}$ | - | 110   | - | ns                     |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                                            | - | 0.76  | - | $\mu\text{C}$          |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                                            | - | 20.5  | - | A                      |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |                                                                                                                            | - | -1640 | - | $\text{A}/\mu\text{s}$ |

**Switching Characteristic, Inductive Load**

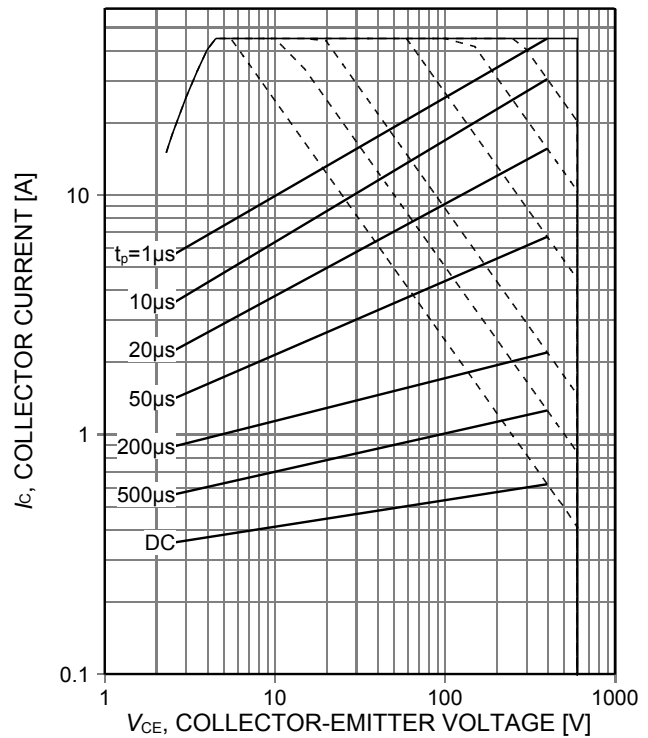
| Parameter                                              | Symbol              | Conditions                                                                                                                                                                                                                             | Value |      |      | Unit |
|--------------------------------------------------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
|                                                        |                     |                                                                                                                                                                                                                                        | min.  | typ. | max. |      |
| IGBT Characteristic, at $T_{vj} = 175^{\circ}\text{C}$ |                     |                                                                                                                                                                                                                                        |       |      |      |      |
| Turn-on delay time                                     | $t_{d(\text{on})}$  | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$V_{CC} = 400\text{V}$ , $I_C = 15.0\text{A}$ ,<br>$V_{GE} = 0.0/15.0\text{V}$ ,<br>$r_G = 15.0\Omega$ , $L\sigma = 60\text{nH}$ ,<br>$C\sigma = 40\text{pF}$<br>$L\sigma$ , $C\sigma$ from Fig. E | -     | 15   | -    | ns   |
| Rise time                                              | $t_r$               |                                                                                                                                                                                                                                        | -     | 11   | -    | ns   |
| Turn-off delay time                                    | $t_{d(\text{off})}$ |                                                                                                                                                                                                                                        | -     | 212  | -    | ns   |
| Fall time                                              | $t_f$               |                                                                                                                                                                                                                                        | -     | 218  | -    | ns   |
| Turn-on energy                                         | $E_{\text{on}}$     |                                                                                                                                                                                                                                        | -     | 0.41 | -    | mJ   |
| Turn-off energy                                        | $E_{\text{off}}$    |                                                                                                                                                                                                                                        | -     | 0.84 | -    | mJ   |
| Total switching energy                                 | $E_{\text{ts}}$     |                                                                                                                                                                                                                                        | -     | 1.25 | -    | mJ   |

**Diode Characteristic, at  $T_{vj} = 175^{\circ}\text{C}$** 

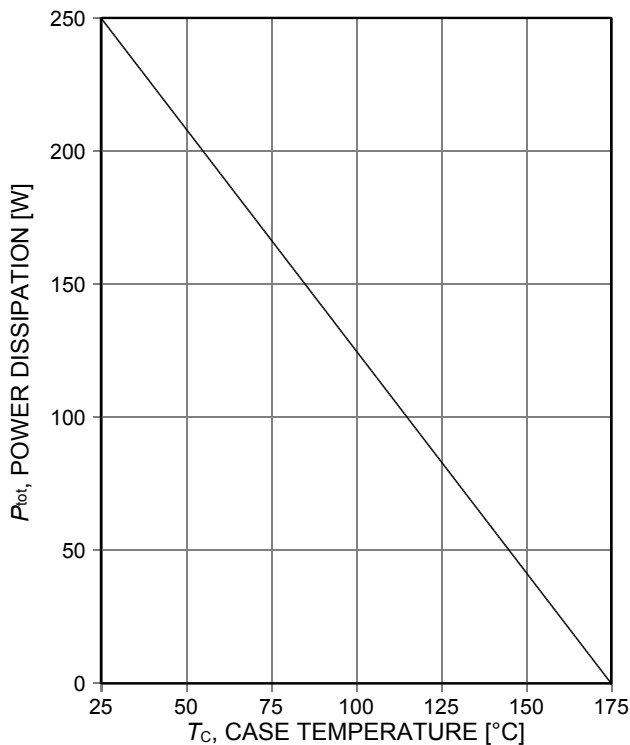
|                                                                  |              |                                                                                                                             |   |      |   |                        |
|------------------------------------------------------------------|--------------|-----------------------------------------------------------------------------------------------------------------------------|---|------|---|------------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$V_R = 400\text{V}$ ,<br>$I_F = 15.0\text{A}$ ,<br>$di_F/dt = 1300\text{A}/\mu\text{s}$ | - | 190  | - | ns                     |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                                             | - | 1.70 | - | $\mu\text{C}$          |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                                             | - | 27.0 | - | A                      |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |                                                                                                                             | - | -280 | - | $\text{A}/\mu\text{s}$ |



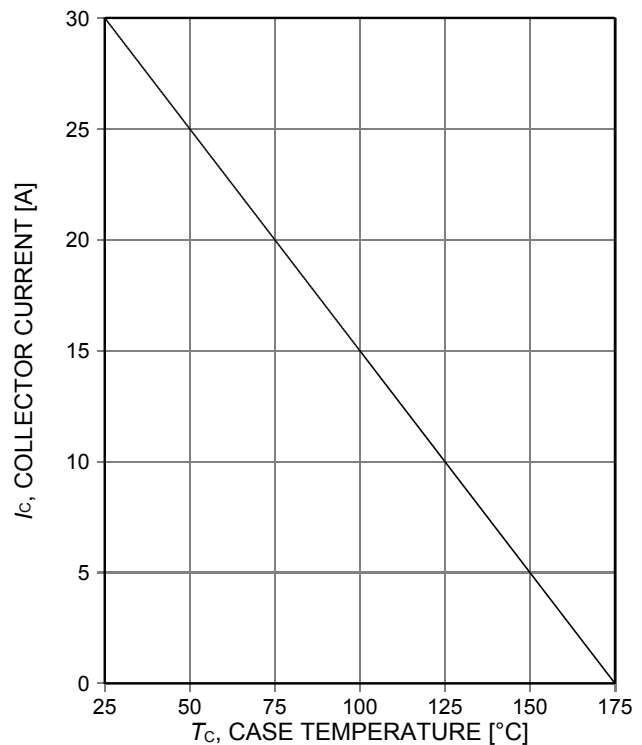
**Figure 1. Collector current as a function of switching frequency**  
 $(T_{vj} \leq 175^\circ\text{C}, T_a = 55^\circ\text{C}, D = 0.5, V_{CE} = 400\text{V}, V_{GE} = 15/0\text{V}, r_G = 15\Omega, \text{PCB mounting with thermal vias and heatsink, see Appnote: } \text{www.infineon.com/igbt})$



**Figure 2. Forward bias safe operating area**  
 $(D = 0, T_C = 25^\circ\text{C}, T_{vj} \leq 175^\circ\text{C}; V_{GE} = 15\text{V})$



**Figure 3. Power dissipation as a function of case temperature**  
 $(T_{vj} \leq 175^\circ\text{C})$



**Figure 4. Collector current as a function of case temperature**  
 $(V_{GE} \geq 15\text{V}, T_{vj} \leq 175^\circ\text{C})$

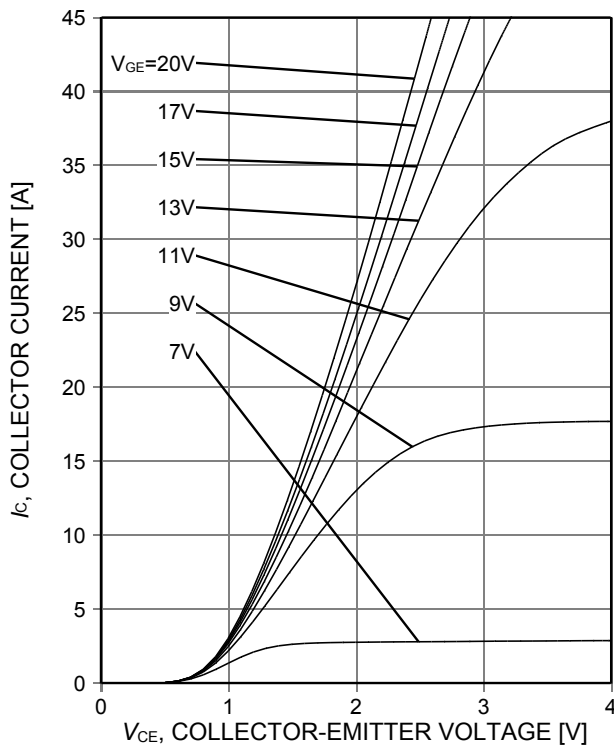


Figure 5. **Typical output characteristic**  
( $T_{vj}=25^{\circ}\text{C}$ )

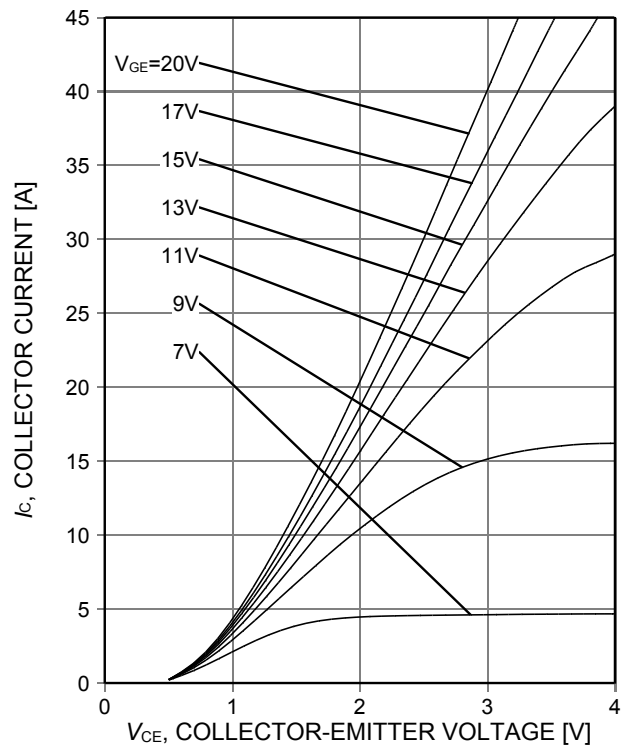


Figure 6. **Typical output characteristic**  
( $T_{vj}=175^{\circ}\text{C}$ )

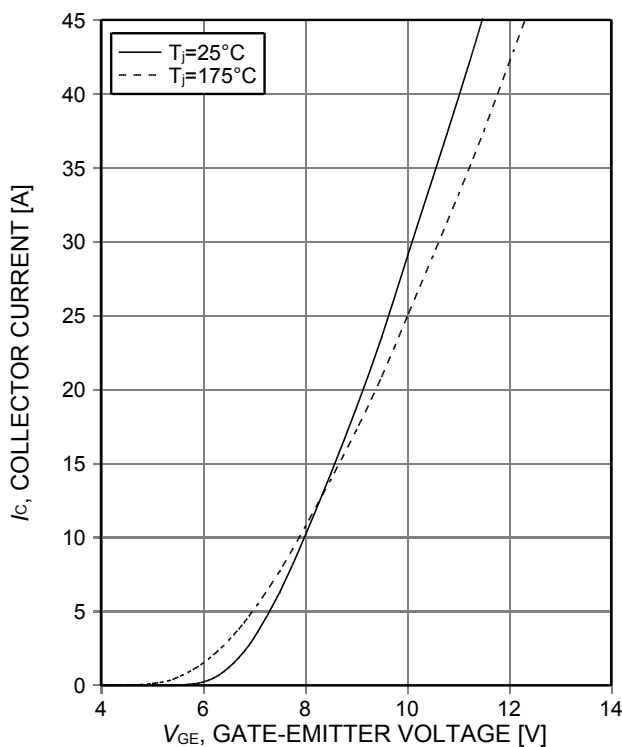


Figure 7. **Typical transfer characteristic**  
( $V_{CE}=10\text{V}$ )

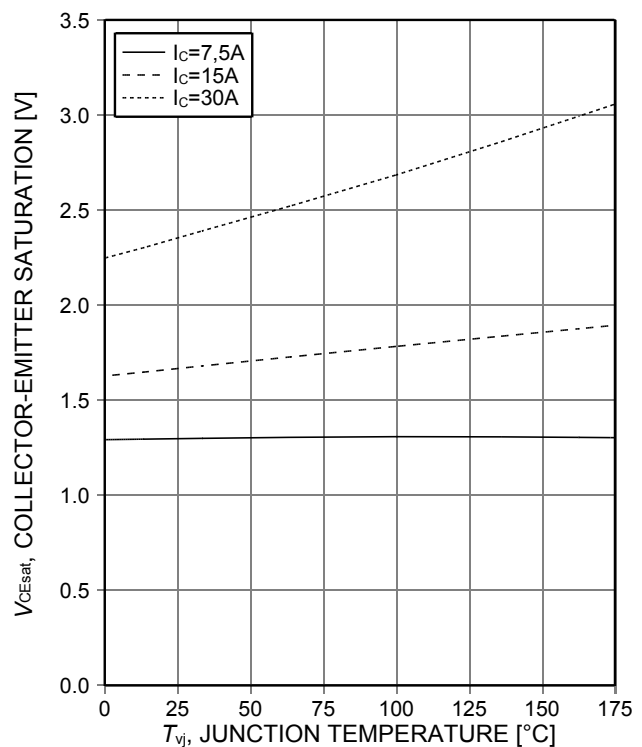


Figure 8. **Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE}=15\text{V}$ )

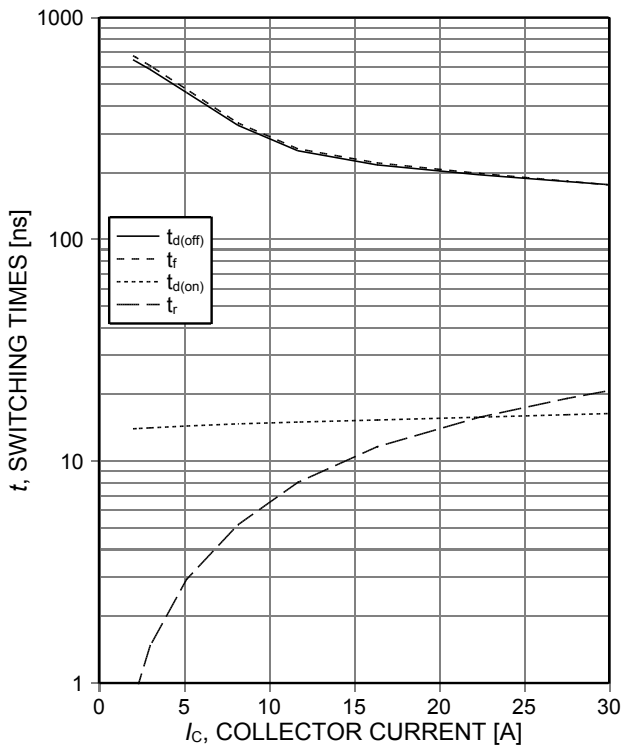


Figure 9. **Typical switching times as a function of collector current**  
(inductive load,  $T_{vj}=175^{\circ}\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $r_G=15\Omega$ , Dynamic test circuit in Figure E)

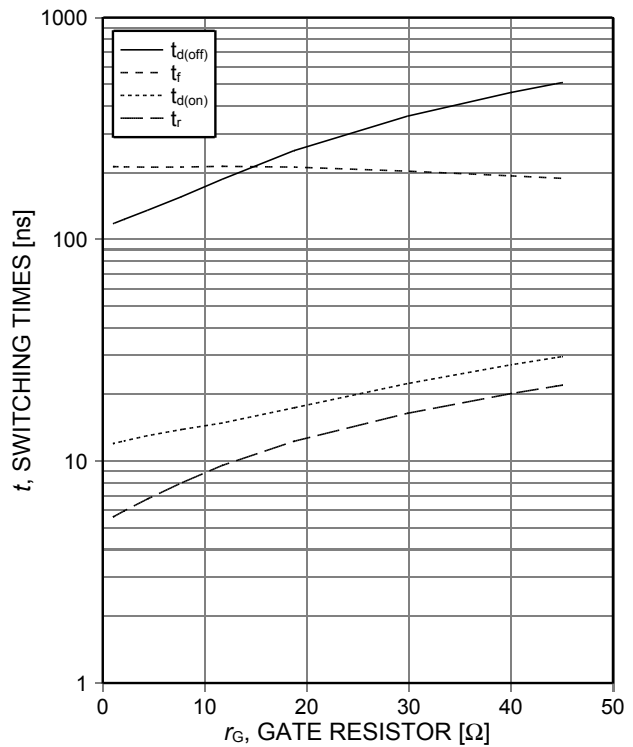


Figure 10. **Typical switching times as a function of gate resistor**  
(inductive load,  $T_{vj}=175^{\circ}\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ , Dynamic test circuit in Figure E)

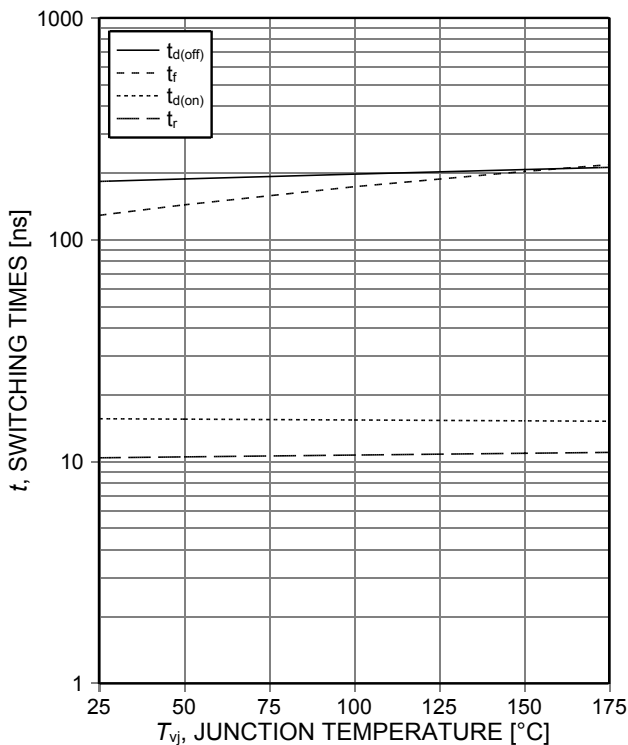


Figure 11. **Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ ,  $r_G=15\Omega$ , Dynamic test circuit in Figure E)

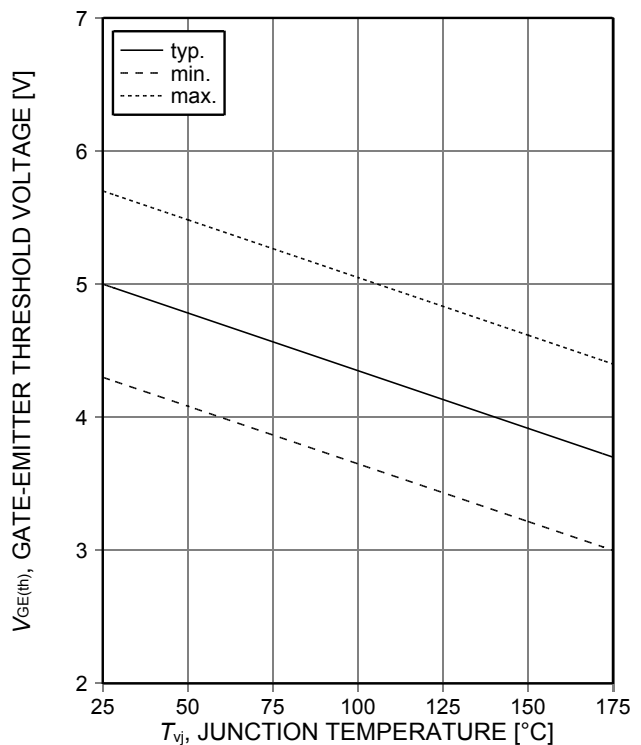


Figure 12. **Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C=0,25\text{mA}$ )

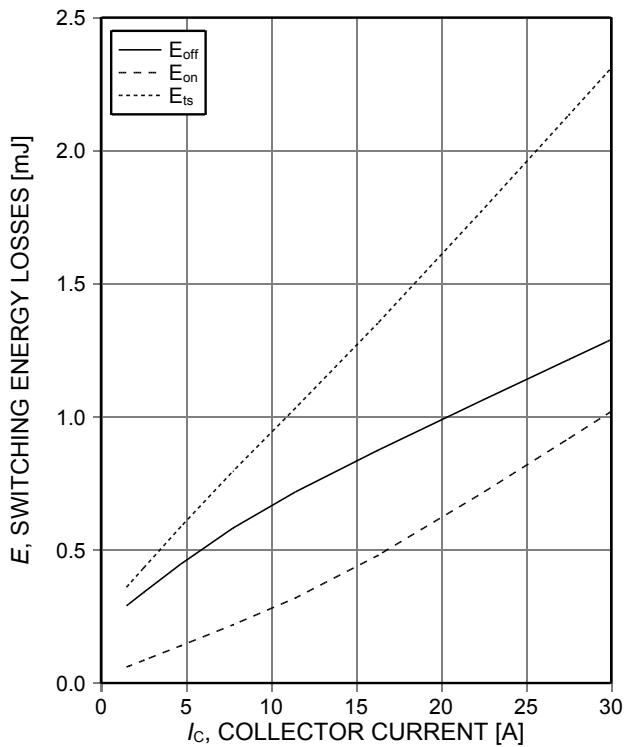


Figure 13. **Typical switching energy losses as a function of collector current**  
(inductive load,  $T_{vj}=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $r_G=15\Omega$ , Dynamic test circuit in Figure E)

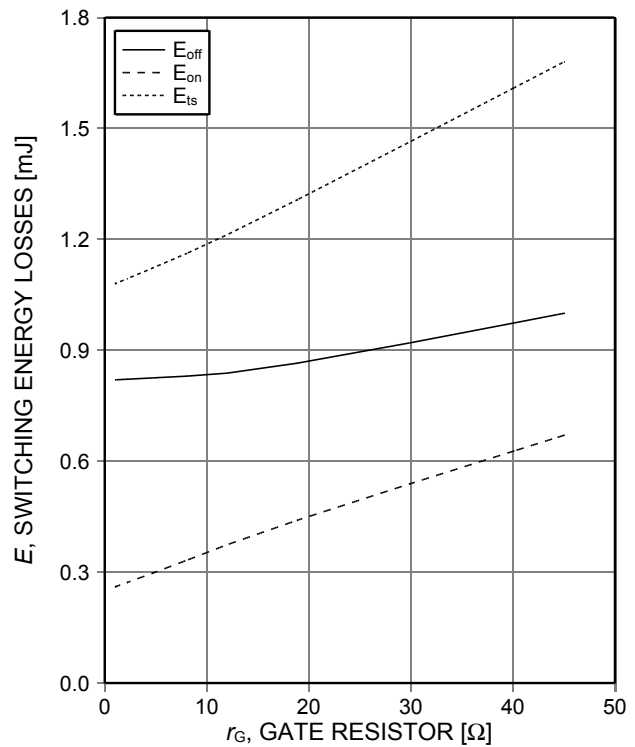


Figure 14. **Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_{vj}=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ , Dynamic test circuit in Figure E)

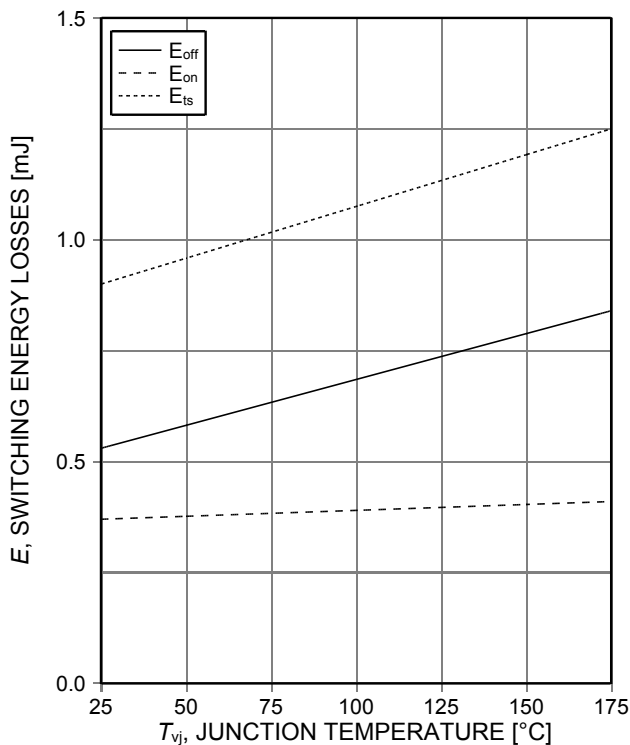


Figure 15. **Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ ,  $r_G=15\Omega$ , Dynamic test circuit in Figure E)

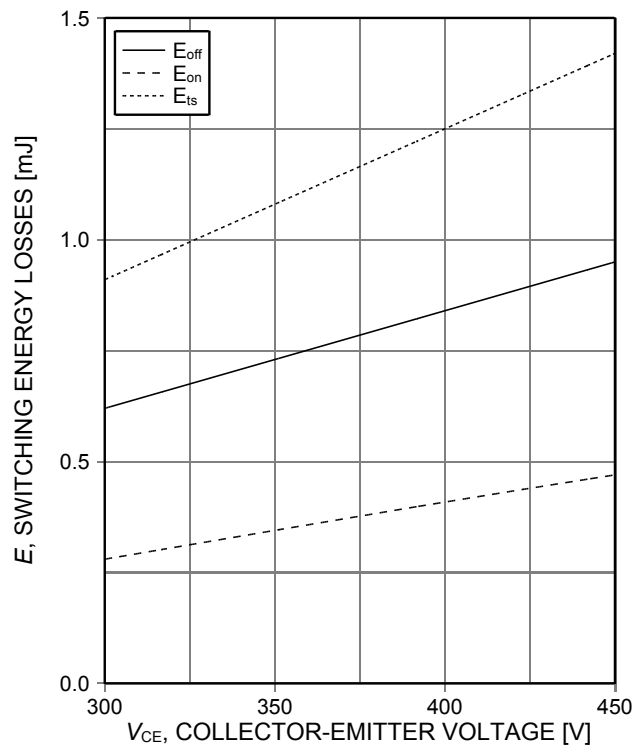


Figure 16. **Typical switching energy losses as a function of collector emitter voltage**  
(inductive load,  $T_{vj}=175^\circ\text{C}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ ,  $r_G=15\Omega$ , Dynamic test circuit in Figure E)

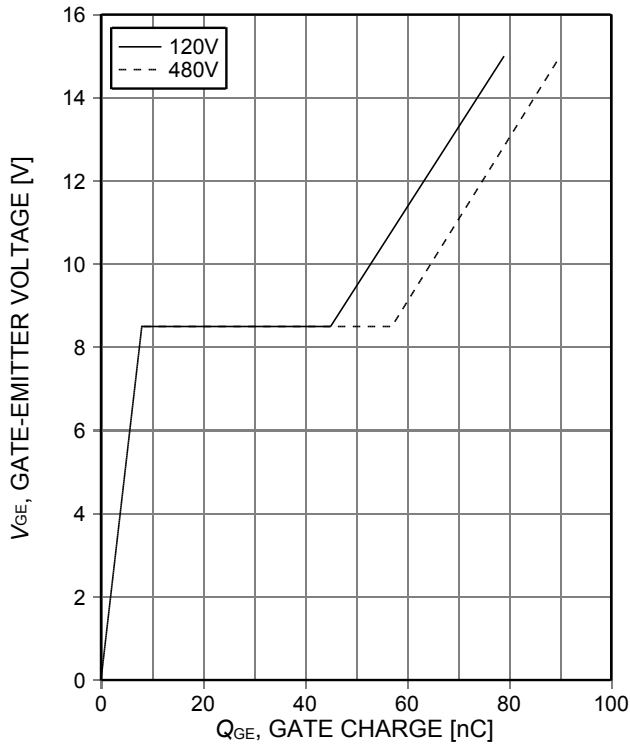


Figure 17. **Typical gate charge**  
( $I_C=15A$ )

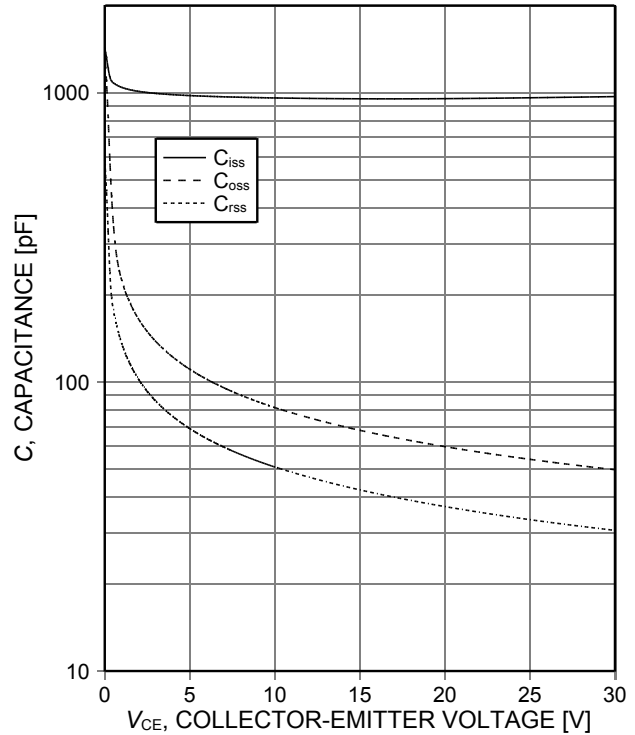


Figure 18. **Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0V$ ,  $f=1MHz$ )

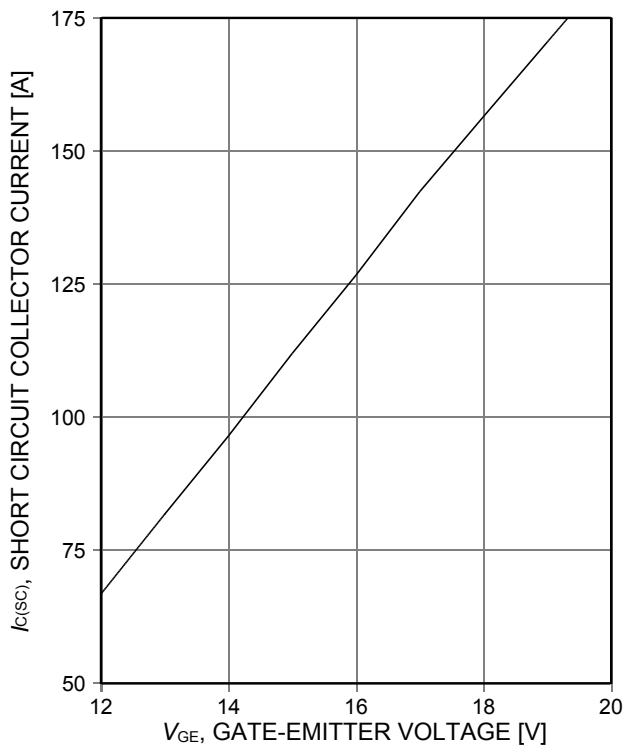


Figure 19. **Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE} \leq 400V$ , start at  $T_{vj}=25^\circ C$ )

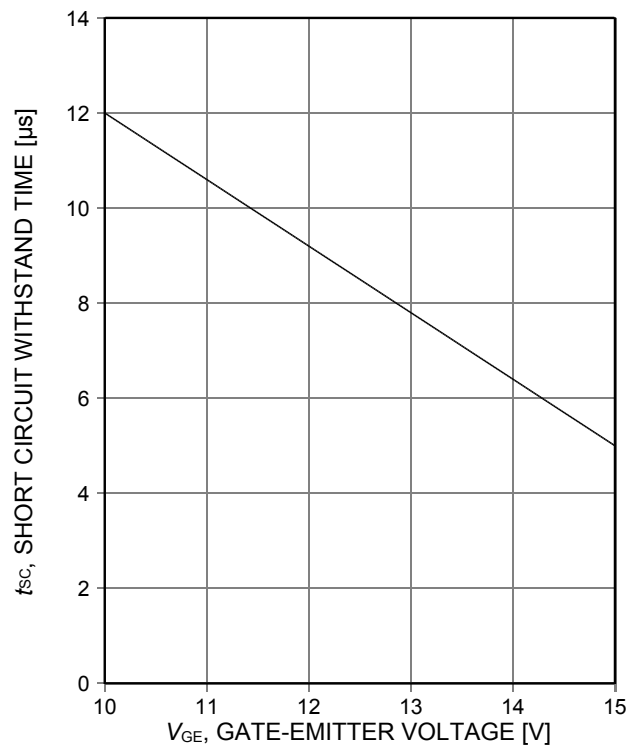


Figure 20. **Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE} \leq 400V$ , start at  $T_{vj}=150^\circ C$ )

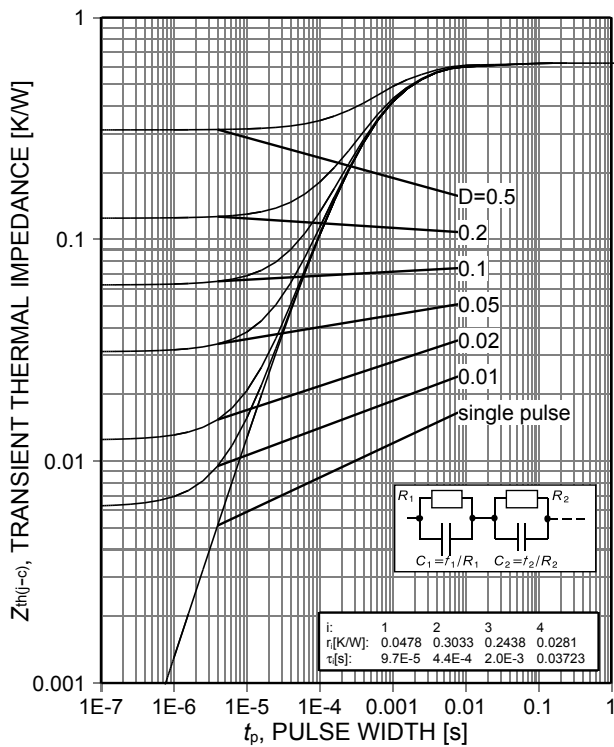


Figure 21. IGBT transient thermal impedance <sup>1)</sup>  
( $D=t_p/T$ )

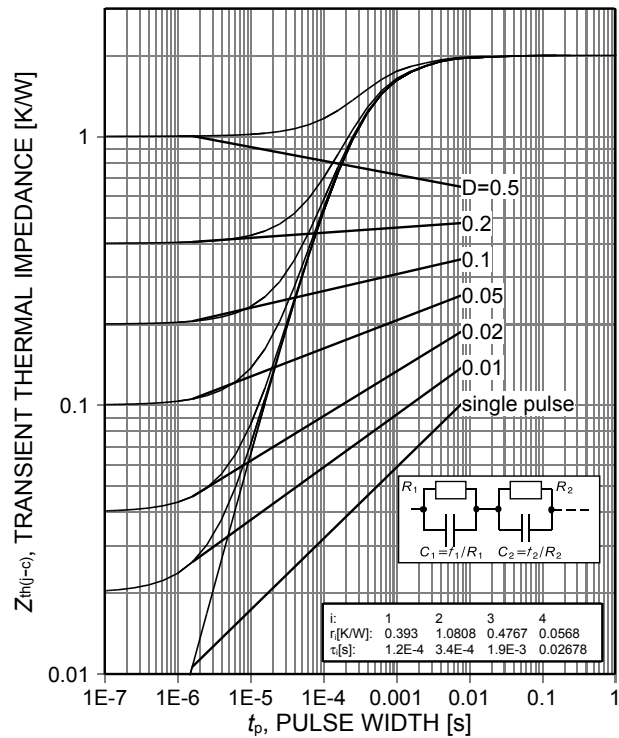


Figure 22. Diode transient thermal impedance as a function of pulse width <sup>1)</sup>  
( $D=t_p/T$ )

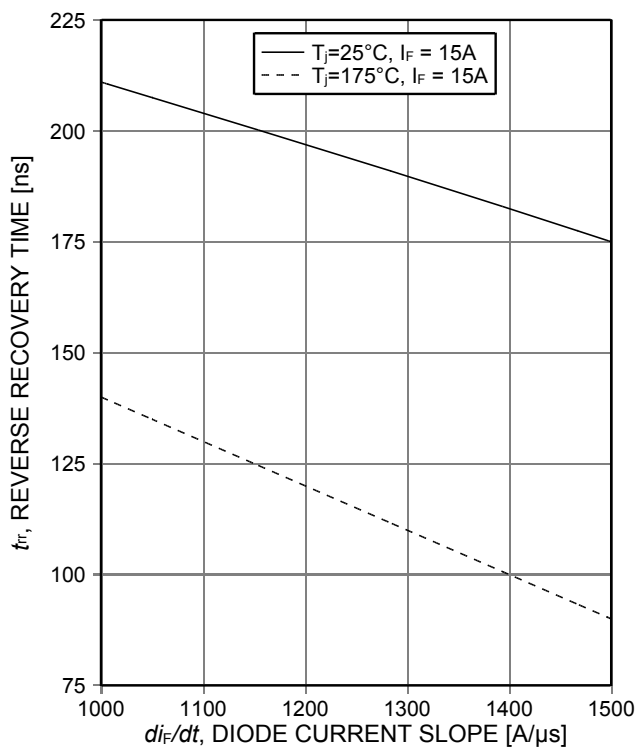


Figure 23. Typical reverse recovery time as a function of diode current slope  
( $V_R=400V$ )

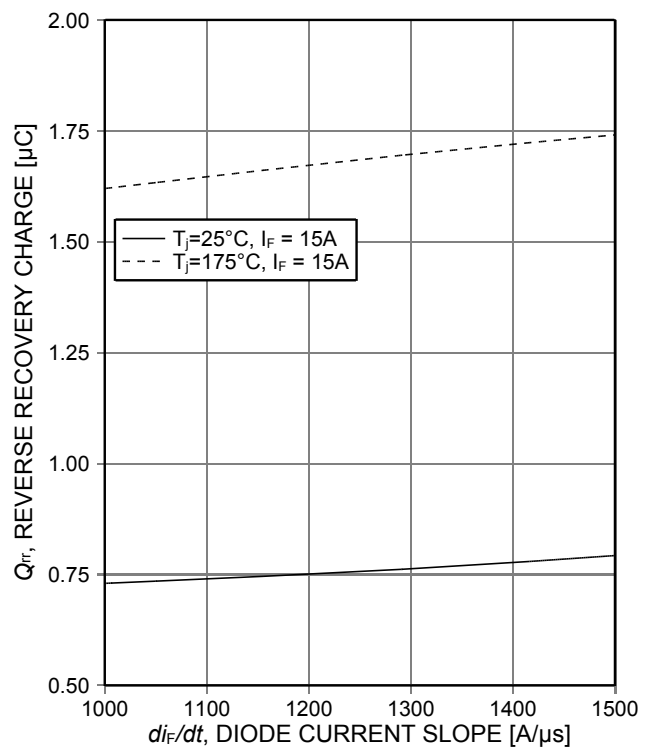


Figure 24. Typical reverse recovery charge as a function of diode current slope  
( $V_R=400V$ )

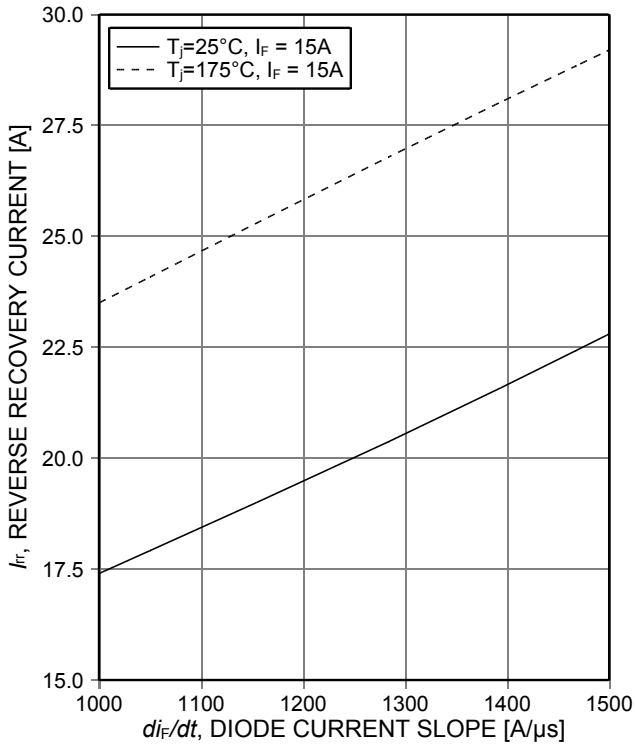


Figure 25. Typical reverse recovery current as a function of diode current slope ( $V_R=400\text{V}$ )

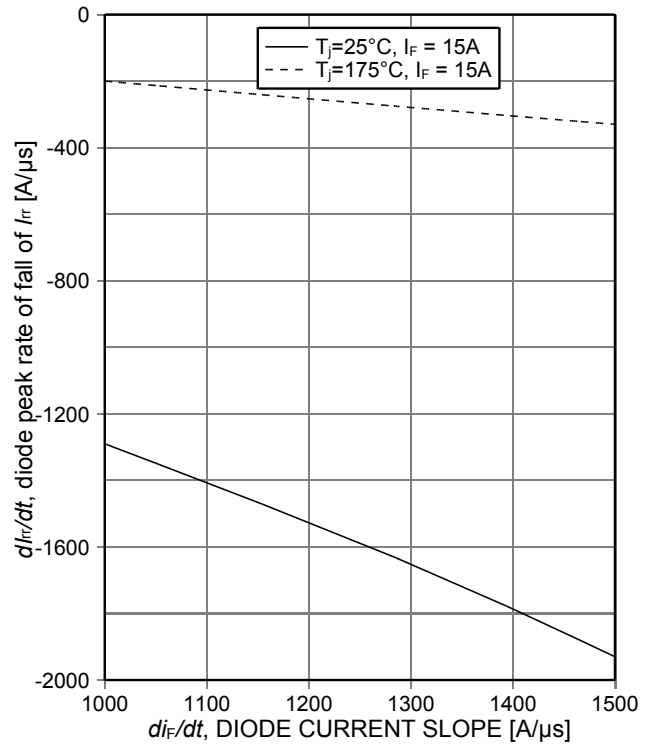


Figure 26. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ( $V_R=400\text{V}$ )

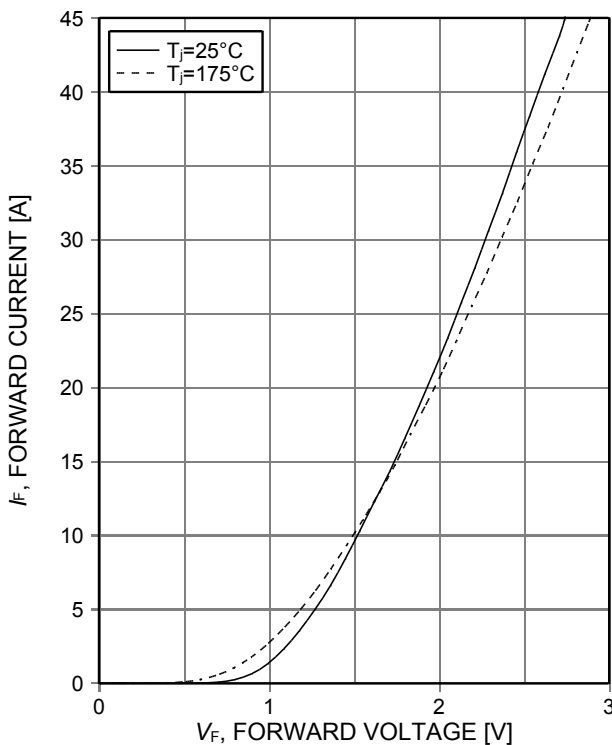


Figure 27. Typical diode forward current as a function of forward voltage

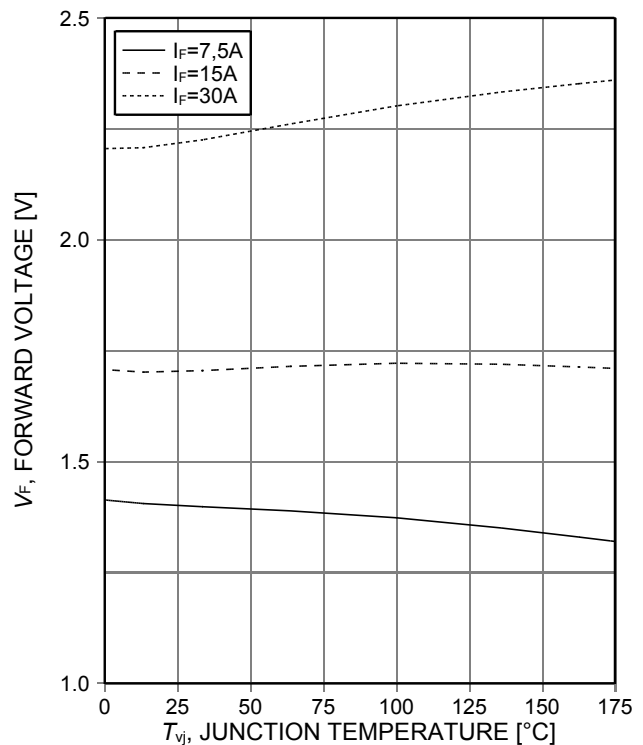
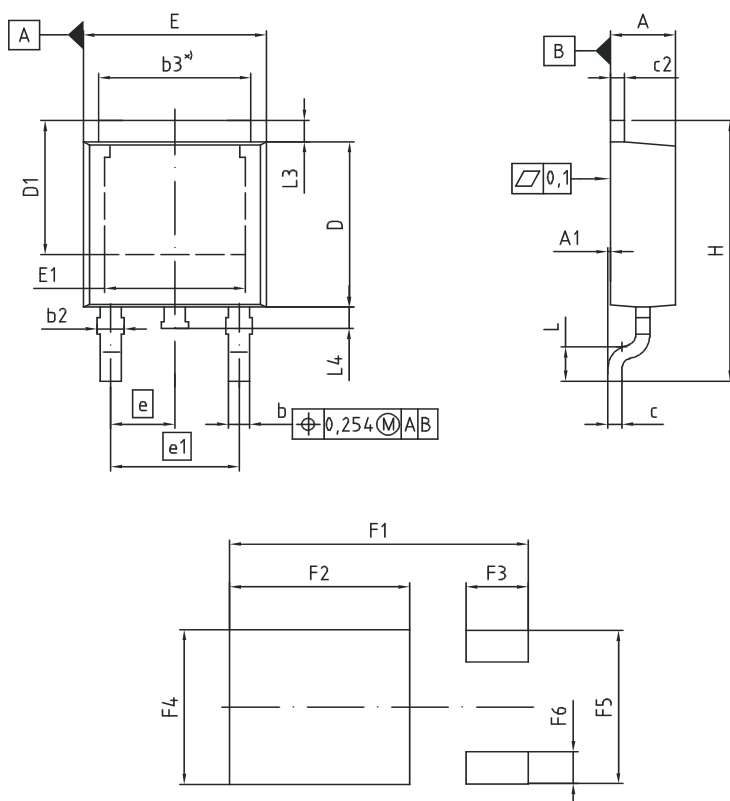


Figure 28. Typical diode forward voltage as a function of junction temperature

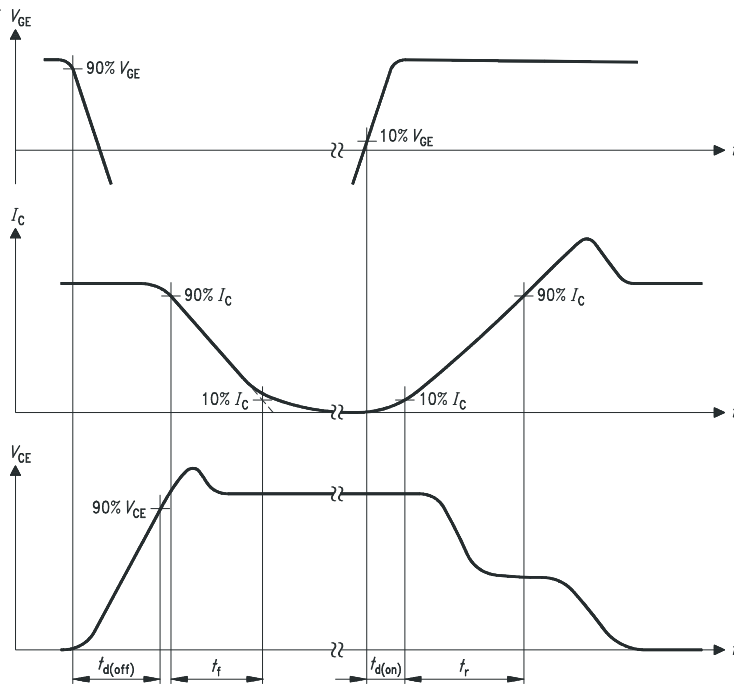
## PG-TO252 -3



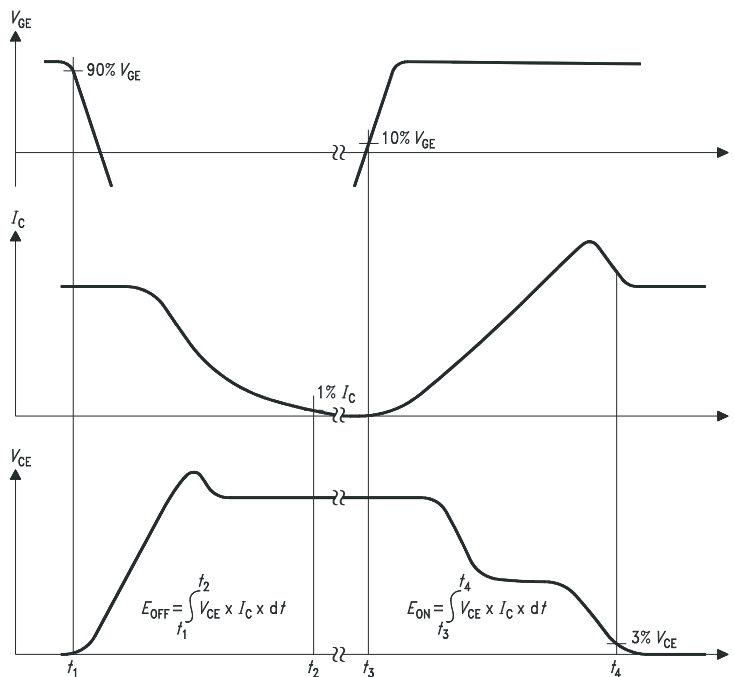
\*) mold flash not included

| DIM | MILLIMETERS |       | INCHES      |       |
|-----|-------------|-------|-------------|-------|
|     | MIN         | MAX   | MIN         | MAX   |
| A   | 2.16        | 2.41  | 0.085       | 0.095 |
| A1  | 0.00        | 0.15  | 0.000       | 0.006 |
| b   | 0.64        | 0.89  | 0.025       | 0.035 |
| b2  | 0.65        | 1.15  | 0.026       | 0.045 |
| b3  | 5.00        | 5.50  | 0.197       | 0.217 |
| c   | 0.46        | 0.60  | 0.018       | 0.024 |
| c2  | 0.46        | 0.98  | 0.018       | 0.039 |
| D   | 5.97        | 6.22  | 0.235       | 0.245 |
| D1  | 5.02        | 5.84  | 0.198       | 0.230 |
| E   | 6.40        | 6.73  | 0.252       | 0.265 |
| E1  | 4.70        | 5.21  | 0.185       | 0.205 |
| e   | 2.29 (BSC)  |       | 0.090 (BSC) |       |
| e1  | 4.57        |       | 0.180       |       |
| N   | 3           |       | 3           |       |
| H   | 9.40        | 10.48 | 0.370       | 0.413 |
| L   | 1.18        | 1.70  | 0.046       | 0.067 |
| L3  | 0.90        | 1.25  | 0.035       | 0.049 |
| L4  | 0.51        | 1.00  | 0.020       | 0.039 |
| F1  | 10.60       |       | 0.417       |       |
| F2  | 6.40        |       | 0.252       |       |
| F3  | 2.20        |       | 0.087       |       |
| F4  | 5.80        |       | 0.228       |       |
| F5  | 5.76        |       | 0.227       |       |
| F6  | 1.20        |       | 0.047       |       |

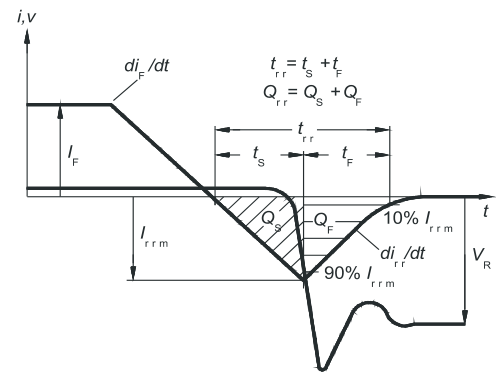
|                                                                                                                     |
|---------------------------------------------------------------------------------------------------------------------|
| <b>DOCUMENT NO.</b><br>Z8B00003328                                                                                  |
| <b>SCALE</b><br>0 2.0 4mm                                                                                           |
| <b>EUROPEAN PROJECTION</b><br> |
| <b>ISSUE DATE</b><br>16-02-2011                                                                                     |
| <b>REVISION</b><br>04                                                                                               |



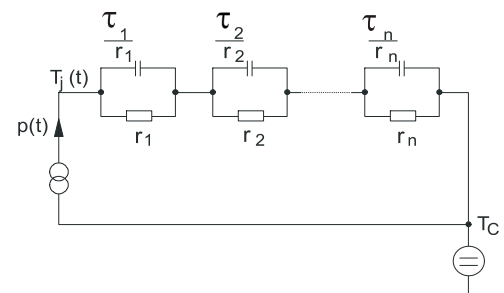
**Figure A. Definition of switching times**



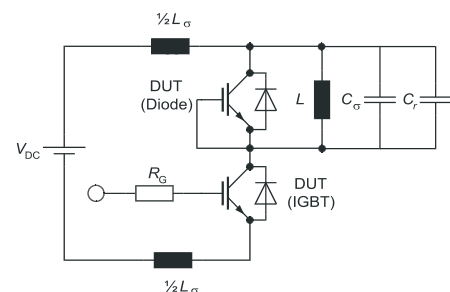
**Figure B. Definition of switching losses**



**Figure C. Definition of diodes switching characteristics**



**Figure D. Thermal equivalent circuit**



**Figure E. Dynamic test circuit**  
Parasitic inductance  $L_\sigma$ ,  
Parasitic capacitor  $C_\sigma$ ,  
Relief capacitor  $C_r$   
(only for ZVT switching)

**Revision History**

IKD15N60RA

**Revision: 2013-02-15, Rev. 2.1**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|----------------------------------------------|
| 2.1      | 2013-02-15 | Final data sheet                             |

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